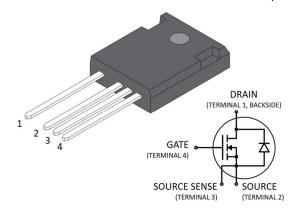


3300 V, 80 mΩ SiC N-Channel Power MOSFET

Product Overview

The silicon carbide (SiC) power MOSFET product line from Microchip increases the performance over silicon MOSFET and silicon IGBT solutions while lowering the total cost of ownership for high-voltage applications. The MSC080SMA330B4 device is a 3300 V, 80 m Ω SiC MOSFET in a TO-247 4-lead package with a source sense.



Features

The following are key features of the MSC080SMA330B4 device:

- Low capacitances and low gate charge
- · Fast switching speed due to low internal gate resistance (ESR)
- Stable operation at high junction temperature, T_{J(max)} = 150 °C
- Fast and reliable body diode
- Superior avalanche ruggedness
- RoHS compliant

Benefits

The following are benefits of the MSC080SMA330B4 device:

- High efficiency to enable lighter, more compact system
- · Simple to drive and easy to parallel
- Improved thermal capabilities and lower switching losses
- Eliminates the need for external freewheeling diode
- · Lower system cost of ownership

Applications

The MSC080SMA330B4 device is designed for the following applications:

- · PV inverter, converter, and industrial motor drives
- Smart grid transmission and distribution
- Induction heating and welding
- H/EV powertrain and EV charger
- Power supply and distribution

1. Device Specifications

This section shows the specifications of the MSC080SMA330B4 device.

1.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings of the MSC080SMA330B4 device.

| Symbol | Parameter | Ratings | Unit |
|------------------|--|-----------|------|
| V _{DSS} | Drain source voltage | 3300 | V |
| I _D | Continuous drain current at T_C = 25 °C | 41 | A |
| | Continuous drain current at T_C = 100 °C | 26 | |
| I _{DM} | Pulsed drain current ¹ | 100 | |
| V _{GS} | Gate-source voltage | 23 to -10 | V |
| PD | Total power dissipation at T_C = 25 °C | 381 | W |
| | Linear derating factor | 3.04 | W/°C |

Table 1-1. Absolute Maximum Ratings

Note:

1. Repetitive rating: pulse width and case temperature limited by maximum junction temperature.

The following table shows the thermal and mechanical characteristics of the MSC080SMA330B4 device.

 Table 1-2. Thermal and Mechanical Characteristics

| Symbol | Characteristic/Test Conditions | Min | Тур | Max | Unit |
|------------------|---|-----|------|------|--------|
| R _{θJC} | Junction-to-case thermal resistance | | 0.22 | 0.33 | °C/W |
| TJ | Operating junction temperature | -55 | | 150 | °C |
| T _{STG} | Storage temperature | -55 | | 150 | °C |
| TL | Soldering temperature for 10 seconds (1.6 mm from case) | | | 300 | °C |
| | Mounting torque, 6-32 or M3 screw | | | 10 | lbf-in |
| | | | | 1.1 | N-m |
| Wt | Package weight | | 0.22 | | oz |
| | | | 6.2 | | g |

1.2 Electrical Performance

The following table shows the static characteristics of the MSC080SMA330B4 device. T_J = 25 $^{\circ}$ C unless otherwise specified.

Table 1-3. Static Characteristics

| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|----------------------|---|---|------|-----|-----|------|
| V _{(BR)DSS} | Drain-source breakdown voltage | V_{GS} = 0 V, I _D = 100 µA | 3300 | | | V |
| R _{DS(on)} | Drain-source on resistance ¹ | V_{GS} = 20 V, I _D = 30 A | | 84 | 105 | mΩ |

Device Specifications

| cor | tinued | | | | | |
|---------------------|---------------------------------|---|-----|------|------|------|
| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
| V _{GS(th)} | Gate-source threshold voltage | $V_{GS} = V_{DS}, I_D = 3 \text{ mA}$ | 1.9 | 2.97 | | V |
| I _{DSS} | Zero gate voltage drain current | V_{DS} = 1200 V, V_{GS} = 0 V | | | 100 | μA |
| | | V _{DS} = 1200 V, V _{GS} = 0 V, T _J = 125 °C | | | 500 | |
| I _{GSS} | Gate-source leakage current | V _{GS} = 20 V/–10 V | | | ±100 | nA |

Note:

1. Pulse test: pulse width < 380 μ s, duty cycle < 2%.

The following table shows the dynamic characteristics of the MSC080SMA330B4 device. T_J = 25 $^{\circ}$ C unless otherwise specified.

| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---|-----|------|-----|------|
| C _{iss} | Input capacitance | $V_{GS} = 0 V$ | | 3462 | | pF |
| C _{rss} | Reverse transfer capacitance | V _{DD} = 2400 V V _{AC} = 25 mV | | 4 | | |
| C _{oss} | Output capacitance | f = 200 kHz | | 77 | | |
| Qg | Total gate charge | $V_{GS} = -5 V/20 V$ $V_{DD} = 2650 V$ | | 55 | | nC |
| Q _{gs} | Gate-source charge | | | 51 | | |
| Q _{gd} | Gate-drain charge | I _D = 30 A | | 161 | | |
| t _{d(on)} | Turn-on delay time | V _{DD} = 2310 V | | 34 | | ns |
| t _r | Voltage rise time | $V_{GS} = -5 V/20 V$ | | 25 | | |
| t _{d(off)} | Turn-off delay time | $I_{\rm D} = 20 {\rm A}$ | | 50 | | |
| t _f | Voltage fall time | $R_{g(ext)} = 8 \Omega$ Freewheeling diode = | | 32 | | |
| Eon | Turn-on switching energy | MSC080SMA330B4 (V _{GS} = -5 | | 1590 | | μJ |
| E _{off} | Turn-off switching energy | V) (reference Fig. 1-20) | | 450 | | |
| t _{d(on)} | Turn-on delay time | V _{DD} = 2310 V | | 35 | | ns |
| t _r | Voltage rise time | $V_{GS} = -5 V/20 V$ | | 18 | | |
| t _{d(off)} | Turn-off delay time | I _D = 20 A | | 50 | | |
| t _f | Voltage fall time | $R_{g(ext)} = 8 \Omega$ | | 22 | | |
| Eon | Turn-on switching energy | Freewheeling diode = MSC030SDA330B (reference | | 1300 | | μJ |
| E _{off} | Turn-off switching energy | Fig. 1-20) | | 360 | | |
| ESR | Gate equivalent series resistance | f = 1 MHz, 25 mV, drain short | | 3.7 | | Ω |
| E _{AS} | Avalanche energy, single pulse | V _{DS} = 150 V, I _D = 30 A | | 100 | | mJ |

Table 1-4. Dynamic Characteristics

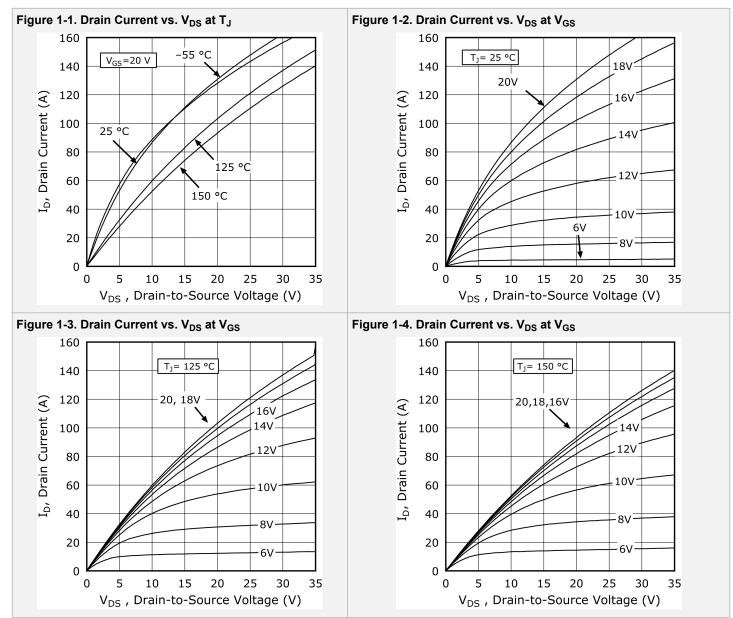
The following table shows the body diode characteristics of the MSC080SMA330B4 device. T_J = 25 $^{\circ}$ C unless otherwise specified.

| | Body Diode Characteristics | |
|--------|----------------------------|----------------|
| Symbol | Characteristic | Tost Condition |

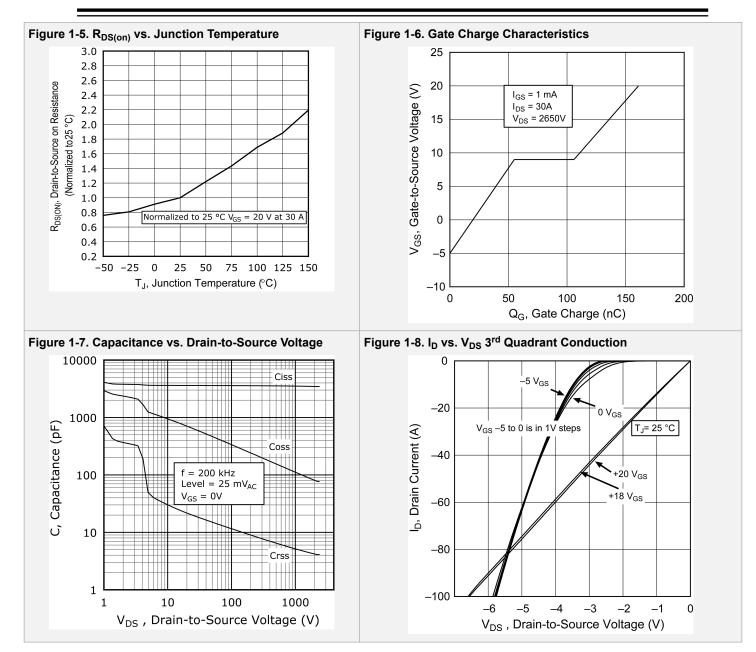
| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|------------------|--------------------------|---|-----|-----|-----|------|
| V _{SD} | Diode forward voltage | I_{SD} = 30 A, V_{GS} = 0 V | | 4.0 | | V |
| | | I_{SD} = 30 A, V_{GS} = –5 V | | 4.2 | | |
| t _{rr} | Reverse recovery time | I_{SD} = 20 A, V_{GS} = -5 V, Drive | | 35 | | ns |
| Q _{rr} | Reverse recovery charge | Rg = 8 Ω, V _{DD} = 2310 V, dl/dt = –3760 A/μs | | 818 | | nC |
| I _{RRM} | Reverse recovery current | | | 41 | | А |

1.3 Typical Performance Curves

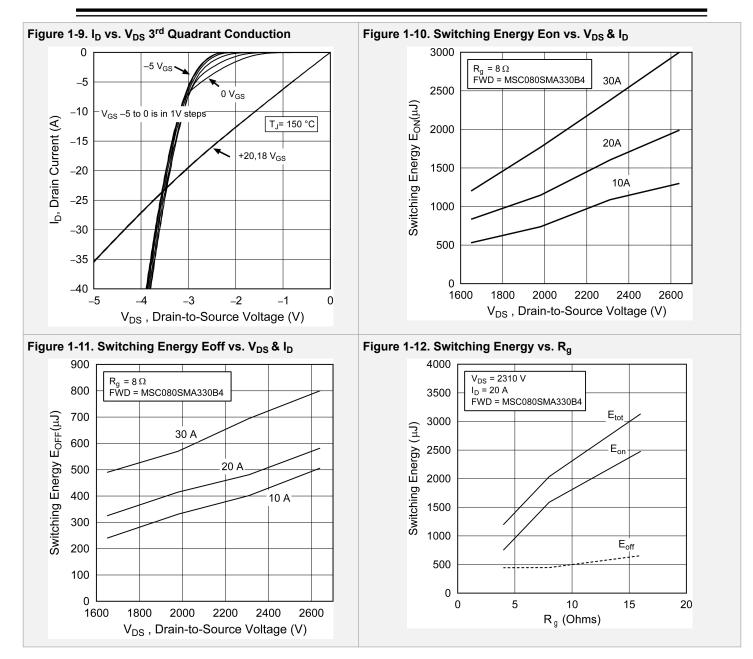
This section shows the typical performance curves of the MSC080SMA330B4 device.



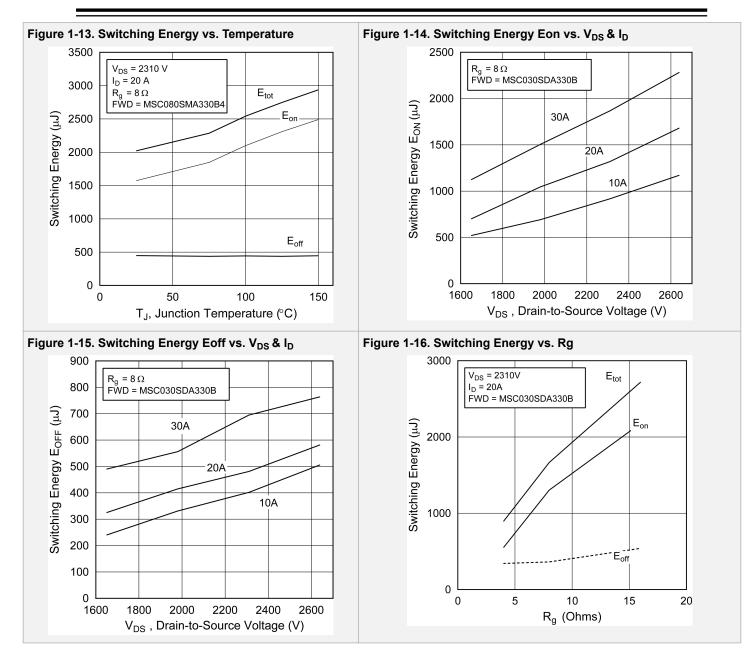
Device Specifications



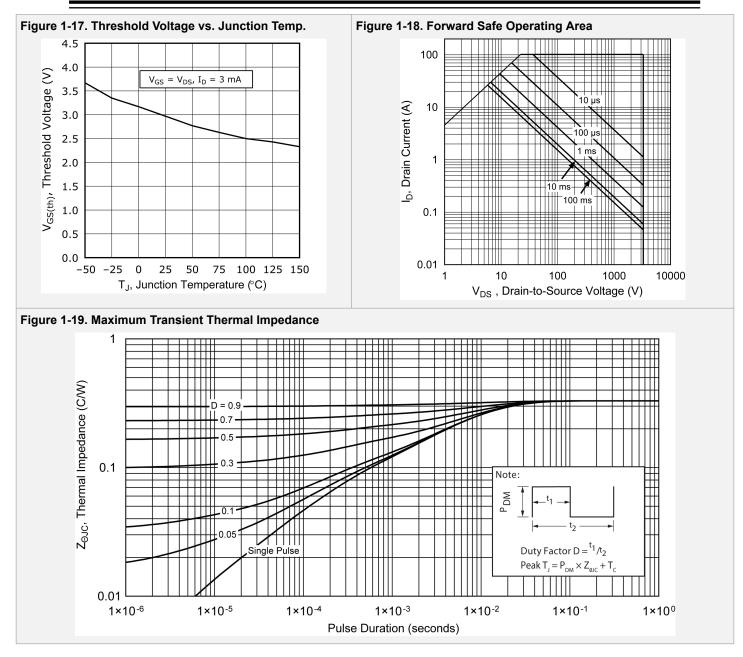
Device Specifications



Device Specifications

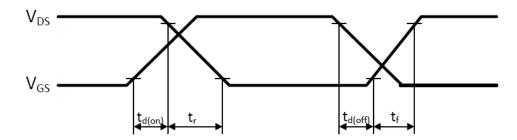


Device Specifications



The following figure shows the switching waveform diagram of the MSC080SMA330B4 device.

Figure 1-20. Switching Waveform



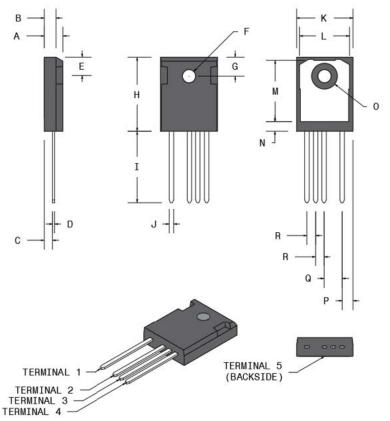
2. Package Specification

This section shows the package specification of the MSC080SMA330B4 device.

2.1 Package Outline Drawing

The following figure illustrates the TO-247-4L package outline of the MSC080SMA330B4 device.

Figure 2-1. Package Outline Drawing



The following table shows the TO-247-4L dimensions and should be used in conjunction with the package outline drawing.

| Symbol | Min (mm) | Max (mm) | Min (in.) | Max (in.) |
|--------|----------|----------|-----------|-----------|
| A | 4.90 | 5.17 | 0.193 | 0.204 |
| В | 1.85 | 2.11 | 0.073 | 0.083 |
| С | 2.25 | 2.51 | 0.089 | 0.099 |
| D | 0.55 | 0.68 | 0.022 | 0.027 |
| E | 5.49 | 5.74 | 0.216 | 0.226 |
| F | 3.56 | 3.66 | 0.140 | 0.144 |
| G | 6.15 BSC | | 0.242 BSC | |
| Н | 20.83 | 21.08 | 0.820 | 0.830 |

Package Specification

| continued | | | | |
|------------|--------------|----------|-----------|-----------|
| Symbol | Min (mm) | Max (mm) | Min (in.) | Max (in.) |
| I | 19.81 | 20.32 | 0.780 | 0.800 |
| J | 1.07 | 1.33 | 0.042 | 0.052 |
| К | 15.77 | 16.03 | 0.621 | 0.631 |
| L | 13.89 | 14.15 | 0.547 | 0.557 |
| Μ | 16.25 | 16.85 | 0.640 | 0.663 |
| Ν | 2.00 | 2.75 | 0.079 | 0.108 |
| 0 | 7.10 | 7.50 | 0.280 | 0.295 |
| Р | 2.87 BSC | | 0.113 BSC | |
| Q | 5.08 BSC | | 0.200 BSC | |
| R | 2.54 BSC | | 0.100 BSC | |
| Terminal 1 | Drain | | | |
| Terminal 2 | Source | | | |
| Terminal 3 | Source sense | | | |
| Terminal 4 | Gate | | | |
| Terminal 5 | Drain | | | |

3. Revision History

Table 3-1. Revision History

| Revision | Date | Description |
|----------|---------|-------------------|
| А | 01/2022 | Document created. |

The Microchip Website

Microchip provides online support via our website at www.microchip.com/. This website is used to make files and information easily available to customers. Some of the content available includes:

- **Product Support** Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- **General Technical Support** Frequently Asked Questions (FAQs), technical support requests, online discussion groups, Microchip design partner program member listing
- **Business of Microchip** Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

Product Change Notification Service

Microchip's product change notification service helps keep customers current on Microchip products. Subscribers will receive email notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, go to www.microchip.com/pcn and follow the registration instructions.

Customer Support

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Embedded Solutions Engineer (ESE)
- Technical Support

Customers should contact their distributor, representative or ESE for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in this document.

Technical support is available through the website at: www.microchip.com/support

Microchip Devices Code Protection Feature

Note the following details of the code protection feature on Microchip products:

- · Microchip products meet the specifications contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is secure when used in the intended manner, within operating specifications, and under normal conditions.
- Microchip values and aggressively protects its intellectual property rights. Attempts to breach the code protection features of Microchip product is strictly prohibited and may violate the Digital Millennium Copyright Act.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not mean that we are guaranteeing the product is "unbreakable". Code protection is constantly evolving. Microchip is committed to continuously improving the code protection features of our products.

Legal Notice

This publication and the information herein may be used only with Microchip products, including to design, test, and integrate Microchip products with your application. Use of this information in any other manner violates these terms. Information regarding device applications is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. Contact your local Microchip sales office for additional support or, obtain additional support at www.microchip.com/en-us/support/design-help/client-support-services.

THIS INFORMATION IS PROVIDED BY MICROCHIP "AS IS". MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE, OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDIRECT, SPECIAL, PUNITIVE, INCIDENTAL, OR CONSEQUENTIAL LOSS, DAMAGE, COST, OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP'S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION.

Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AnyRate, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, CryptoMemory, CryptoRF, dsPIC, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Kleer, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AgileSwitch, APT, ClockWorks, The Embedded Control Solutions Company, EtherSynch, Flashtec, Hyper Speed Control, HyperLight Load, IntelliMOS, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet- Wire, SmartFusion, SyncWorld, Temux, TimeCesium, TimeHub, TimePictra, TimeProvider, TrueTime, WinPath, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, Augmented Switching, BlueSky, BodyCom, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, Espresso T1S, EtherGREEN, GridTime, IdealBridge, In-Circuit Serial Programming, ICSP, INICnet, Intelligent Paralleling, Inter-Chip Connectivity, JitterBlocker, Knob-on-Display, maxCrypto, maxView, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, NVM Express, NVMe, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, RTAX, RTG4, SAM-ICE, Serial Quad I/O, simpleMAP, SimpliPHY, SmartBuffer, SmartHLS, SMART-I.S., storClad, SQI, SuperSwitcher, SuperSwitcher II, Switchtec, SynchroPHY, Total Endurance, TSHARC, USBCheck, VariSense, VectorBlox, VeriPHY, ViewSpan, WiperLock, XpressConnect, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, Symmcom, and Trusted Time are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

[©] 2022, Microchip Technology Incorporated and its subsidiaries. All Rights Reserved.

ISBN: 978-1-5224-9629-8

Quality Management System

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.



Worldwide Sales and Service

| AMERICAS | ASIA/PACIFIC | ASIA/PACIFIC | EUROPE |
|---|---|---|--|
| | | | |
| Corporate Office 355 West Chandler Blvd. | Australia - Sydney Tel: 61-2-9868-6733 | India - Bangalore Tel: 91-80-3090-4444 | Austria - Wels Tel: 43-7242-2244-39 |
| | China - Beijing | India - New Delhi | Fax: 43-7242-2244-39 |
| handler, AZ 85224-6199 | Tel: 86-10-8569-7000 | Tel: 91-11-4160-8631 | Denmark - Copenhager |
| el: 480-792-7200 | | | |
| ax: 480-792-7277 | China - Chengdu | India - Pune | Tel: 45-4485-5910 |
| echnical Support: | Tel: 86-28-8665-5511 | Tel: 91-20-4121-0141 | Fax: 45-4485-2829 |
| ww.microchip.com/support | China - Chongqing | Japan - Osaka Tel: 81-6-6152-7160 | Finland - Espoo |
| Veb Address: | Tel: 86-23-8980-9588 | | Tel: 358-9-4520-820 |
| ww.microchip.com | China - Dongguan | Japan - Tokyo | France - Paris |
| tlanta | Tel: 86-769-8702-9880 | Tel: 81-3-6880- 3770 | Tel: 33-1-69-53-63-20 |
| uluth, GA | China - Guangzhou | Korea - Daegu | Fax: 33-1-69-30-90-79 |
| el: 678-957-9614 | Tel: 86-20-8755-8029 | Tel: 82-53-744-4301 | Germany - Garching |
| ax: 678-957-1455 | China - Hangzhou | Korea - Seoul | Tel: 49-8931-9700 |
| ustin, TX | Tel: 86-571-8792-8115 | Tel: 82-2-554-7200 | Germany - Haan |
| el: 512-257-3370 | China - Hong Kong SAR | Malaysia - Kuala Lumpur | Tel: 49-2129-3766400 |
| oston | Tel: 852-2943-5100 | Tel: 60-3-7651-7906 | Germany - Heilbronn |
| /estborough, MA | China - Nanjing | Malaysia - Penang | Tel: 49-7131-72400 |
| el: 774-760-0087 | Tel: 86-25-8473-2460 | Tel: 60-4-227-8870 | Germany - Karlsruhe |
| ax: 774-760-0088 | China - Qingdao | Philippines - Manila | Tel: 49-721-625370 |
| hicago | Tel: 86-532-8502-7355 | Tel: 63-2-634-9065 | Germany - Munich |
| asca, IL | China - Shanghai | Singapore | Tel: 49-89-627-144-0 |
| el: 630-285-0071 | Tel: 86-21-3326-8000 | Tel: 65-6334-8870 | Fax: 49-89-627-144-44 |
| ax: 630-285-0075 | China - Shenyang | Taiwan - Hsin Chu | Germany - Rosenheim |
| allas | Tel: 86-24-2334-2829 | Tel: 886-3-577-8366 | Tel: 49-8031-354-560 |
| ddison, TX | China - Shenzhen | Taiwan - Kaohsiung | Israel - Ra'anana |
| el: 972-818-7423 | Tel: 86-755-8864-2200 | Tel: 886-7-213-7830 | Tel: 972-9-744-7705 |
| ax: 972-818-2924 | China - Suzhou | Taiwan - Taipei | Italy - Milan |
| etroit | Tel: 86-186-6233-1526 | Tel: 886-2-2508-8600 | Tel: 39-0331-742611 |
| ovi, MI | China - Wuhan | Thailand - Bangkok | Fax: 39-0331-466781 |
| el: 248-848-4000 | Tel: 86-27-5980-5300 | Tel: 66-2-694-1351 | Italy - Padova |
| ouston, TX | China - Xian | Vietnam - Ho Chi Minh | Tel: 39-049-7625286 |
| el: 281-894-5983 | Tel: 86-29-8833-7252 | Tel: 84-28-5448-2100 | Netherlands - Drunen |
| Idianapolis | China - Xiamen | | Tel: 31-416-690399 |
| oblesville, IN | Tel: 86-592-2388138 | | Fax: 31-416-690340 |
| el: 317-773-8323 | China - Zhuhai | | Norway - Trondheim |
| ax: 317-773-5453 | Tel: 86-756-3210040 | | Tel: 47-72884388 |
| el: 317-536-2380 | | | Poland - Warsaw |
| os Angeles | | | Tel: 48-22-3325737 |
| lission Viejo, CA | | | Romania - Bucharest |
| el: 949-462-9523 | | | Tel: 40-21-407-87-50 |
| ax: 949-462-9608 | | | Spain - Madrid |
| el: 951-273-7800 | | | Tel: 34-91-708-08-90 |
| aleigh, NC | | | Fax: 34-91-708-08-91 |
| el: 919-844-7510 | | | Sweden - Gothenberg |
| ew York, NY | | | Tel: 46-31-704-60-40 |
| el: 631-435-6000 | | | Sweden - Stockholm |
| an Jose, CA | | | Tel: 46-8-5090-4654 |
| el: 408-735-9110 | | | UK - Wokingham |
| el: 408-436-4270 | | | Tel: 44-118-921-5800 |
| anada - Toronto | | | Fax: 44-118-921-5820 |
| anada - Toronto el: 905-695-1980 | | | 1 an. 44-110-921-9020 |
| | | | |
| ax: 905-695-2078 | | | |

Datasheet